

#### Features

- SMPTE 259M and SMPTE 344M compliant
- Dual coaxial cable driving outputs with selectable slew rate
- 50Ω differential PECL input
- Pb-free and RoHS compliant
- Seamless interface to other HD-LINX® II family products
- Single 3.3V power supply operation
- Operating temperature range: 0°C to 70°C

#### Applications

- SMPTE 259M and SMPTE 344M Coaxial Cable Serial Digital Interfaces.

#### Description

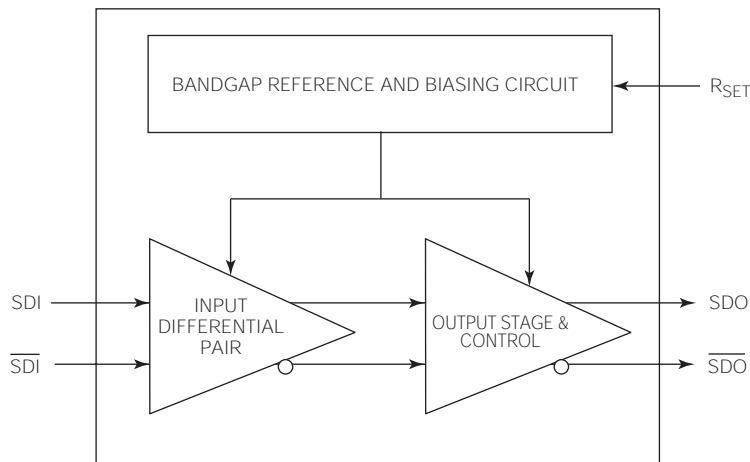
The GS9078A is a second generation high-speed BiCMOS integrated circuit designed to drive one or two 75Ω co-axial cables.

The GS9078A may drive data rates up to 540Mb/s and provides two selectable slew rates in order to achieve compliance to SMPTE 259M and SMPTE 344M.

The GS9078A accepts a LVPECL level differential input that may be AC coupled. External biasing resistors at the inputs are not required.

Power consumption is typically 168mW using a 3.3V power supply. The GS9078A is Pb-free, and the encapsulation compound does not contain halogenated flame retardant.

This component and all homogeneous subcomponents are RoHS compliant.



**Functional Block Diagram**

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# 1. Pin Out

## 1.1 Pin Assignment

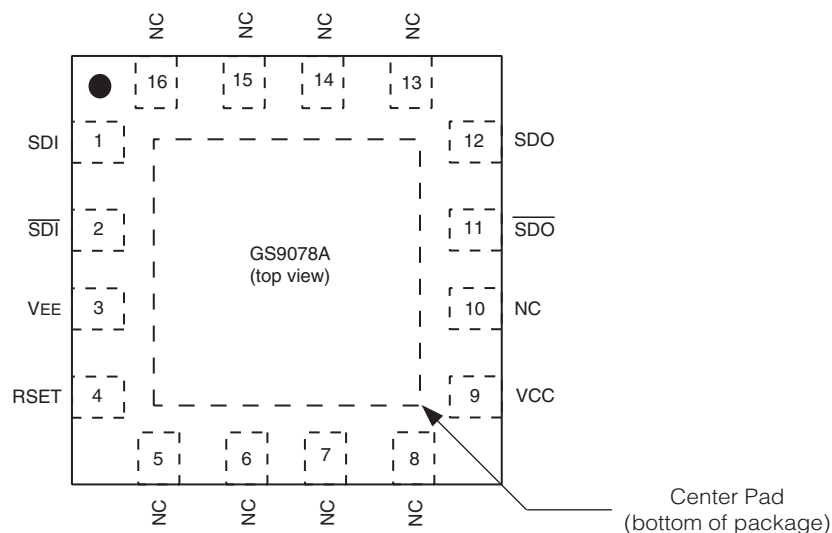


Figure 1-1: 16-Pin QFN

## 1.2 Pin Descriptions

Table 1-1: Pin Descriptions

| Pin Number                 | Name                          | Timing | Type   | Description                                                                                                                         |
|----------------------------|-------------------------------|--------|--------|-------------------------------------------------------------------------------------------------------------------------------------|
| 1,2                        | SDI, $\overline{\text{SDI}}$  | Analog | Input  | Serial digital differential input.                                                                                                  |
| 3                          | $V_{EE}$                      | –      | Power  | Most negative power supply connection. Connect to GND.                                                                              |
| 4                          | $R_{SET}$                     | Analog | Input  | External output amplitude control resistor.                                                                                         |
| 5,6,7,8,10,<br>13,14,15,16 | NC                            | –      | –      | No Connect. Not bonded internally.                                                                                                  |
| 9                          | $V_{CC}$                      | –      | Power  | Most positive power supply connection. Connect to +3.3V.                                                                            |
| 11,12                      | $\overline{\text{SDO}}$ , SDO | Analog | Output | Serial digital differential output.                                                                                                 |
| –                          | Center Pad                    | –      | Power  | Connect to most negative power supply plane following the recommendations in <a href="#">Recommended PCB Footprint on page 13</a> . |

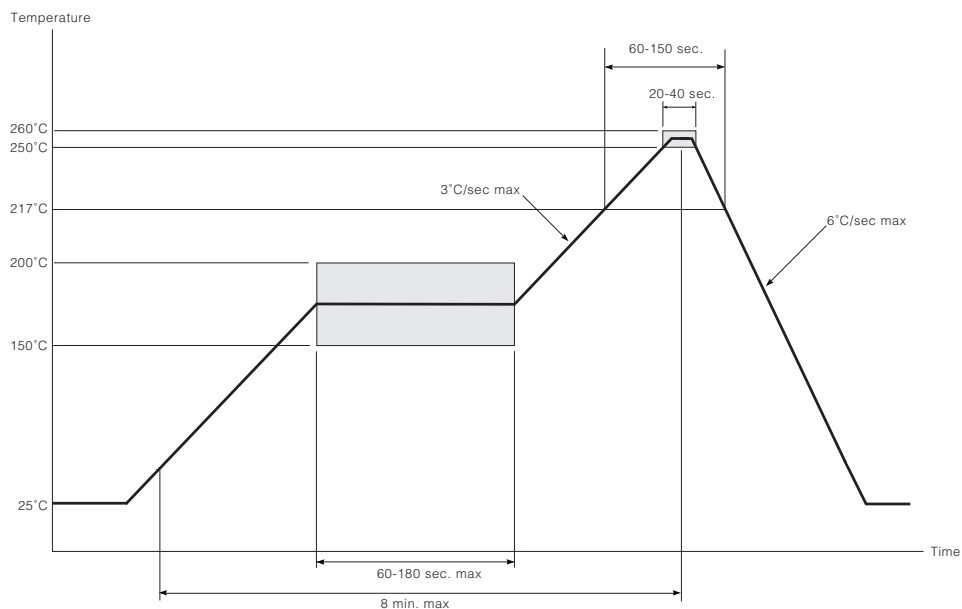
## 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

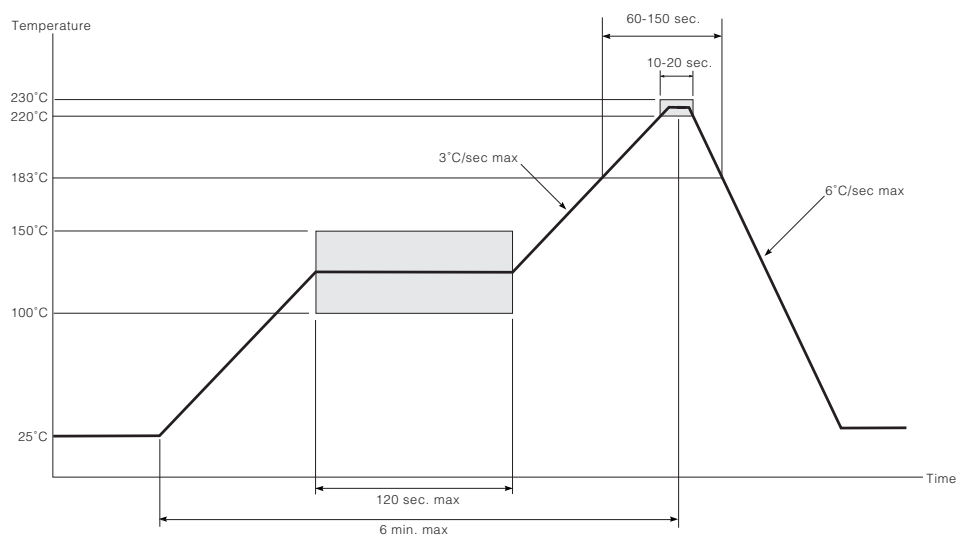
| Parameter                       | Value                            |
|---------------------------------|----------------------------------|
| Supply Voltage                  | -0.5V to 3.6 V <sub>DC</sub>     |
| Input ESD Voltage               | 2kV                              |
| Storage Temperature Range       | -50°C < T <sub>s</sub> < 125°C   |
| Input Voltage Range (any input) | -0.3 to (V <sub>CC</sub> + 0.3)V |
| Operating Temperature Range     | 0°C to 70°C                      |
| Reflow Temperature              | 260°C                            |

### 2.2 Solder Reflow Profiles

The device is manufactured with Matte-Sn terminations and is compatible with both standard eutectic and Pb-free solder reflow profiles. MSL qualification was performed using the maximum Pb-free reflow profile shown in [Figure 2-1](#). The recommended standard Pb reflow profile is shown in [Figure 2-2](#).



**Figure 2-1: Maximum Pb-free Solder Reflow Profile (Preferred)**



**Figure 2-2: Standard Pb Reflow Profile (Pb-free package)**

## 2.3 DC Electrical Characteristics

**Table 2-1: DC Electrical Characteristics**

$V_{DD} = 3.3V$ ,  $T_A = 0^{\circ}C$  to  $70^{\circ}C$ , unless otherwise shown

| Parameter         | Symbol      | Conditions          | Min                      | Typ                | Max                         | Units |
|-------------------|-------------|---------------------|--------------------------|--------------------|-----------------------------|-------|
| Supply Voltage    | $V_{CC}$    | –                   | 3.135                    | 3.3                | 3.465                       | V     |
| Power Consumption | $P_D$       | $T_A = 25^{\circ}C$ | –                        | 168                | –                           | mW    |
| Supply Current    | $I_s$       | $T_A = 25^{\circ}C$ | –                        | 51                 | 64                          | mA    |
| Output Voltage    | $V_{CMOUT}$ | Common mode         | –                        | $V_{CC} - V_{OUT}$ | –                           | V     |
| Input Voltage     | $V_{CMIN}$  | Common mode         | $1.6 + \Delta V_{SDI}/2$ | –                  | $V_{CC} - \Delta V_{SDI}/2$ | V     |

## 2.4 AC Electrical Characteristics

**Table 2-2: AC Electrical Characteristics**

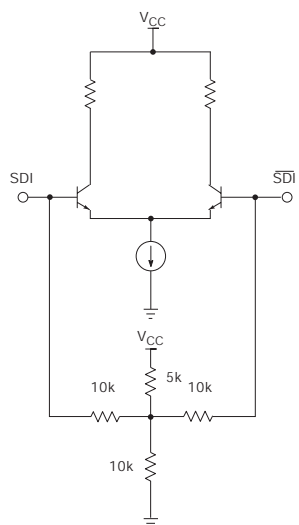
$V_{DD} = 3.3V$ ,  $T_A = 0^{\circ}C$  to  $70^{\circ}C$ , unless otherwise shown

| Parameter                  | Symbol                   | Conditions                                                              | Min | Typ | Max  | Units             | Notes |
|----------------------------|--------------------------|-------------------------------------------------------------------------|-----|-----|------|-------------------|-------|
| Serial input data rate     | $DR_{SDO}$               | –                                                                       | –   | –   | 540  | Mb/s              | 1     |
| Additive jitter            | –                        | –                                                                       | –   | 20  | –    | ps <sub>p-p</sub> | –     |
| Rise/Fall time             | $t_r, t_f$               | –                                                                       | 400 | –   | 800  | ps                | 2     |
| Mismatch in rise/fall time | $\Delta t_r, \Delta t_f$ | –                                                                       | –   | –   | 30   | ps                | –     |
| Duty cycle distortion      | –                        | –                                                                       | –   | –   | 100  | ps                | –     |
| Overshoot                  | –                        | –                                                                       | –   | –   | 8    | %                 | –     |
| Output Return Loss         | ORL                      | –                                                                       | 15  | –   | –    | dB                | –     |
| Output Voltage Swing       | $V_{OUT}$                | Single Ended into 75 $\Omega$<br>external load<br>$R_{SET} = 750\Omega$ | 750 | 800 | 850  | mV <sub>p-p</sub> | –     |
| Input Voltage Swing        | $\Delta V_{SDI}$         | Differential                                                            | 300 | –   | 2200 | mV <sub>p-p</sub> | –     |

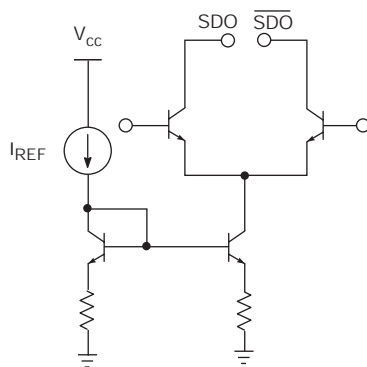
**NOTES:**

1. The input coupling capacitor must be set accordingly for lower data rates.
2. Rise/Fall time measured between 20% and 80%.

### 3. Input / Output Circuits



**Figure 3-1: Differential Input Stage (SDI/ $\overline{\text{SDI}}$ )**



**Figure 3-2: Differential Output Stage (SDO/ $\overline{\text{SDO}}$ )**

## 4. Detailed Description

### 4.1 Input Interfacing

SDI/ $\overline{\text{SDI}}$  are high impedance differential inputs. The equivalent input circuit is shown in [Figure 3-1](#).

Several conditions must be observed when interfacing to these inputs:

- The differential input signal amplitude must be between 300 and 2000mVpp.
- The common mode voltage range must be as specified in the [DC Electrical Characteristics on page 5](#).
- For input trace lengths longer than approximately 1cm, the inputs should be terminated as shown in the Typical Application Circuit.

The GS9078A inputs are self-biased, allowing for simple AC coupling to the device. For serial digital video, a minimum capacitor value of 4.7 $\mu$ F should be used to allow coupling of pathological test signals. A tantalum capacitor is recommended.

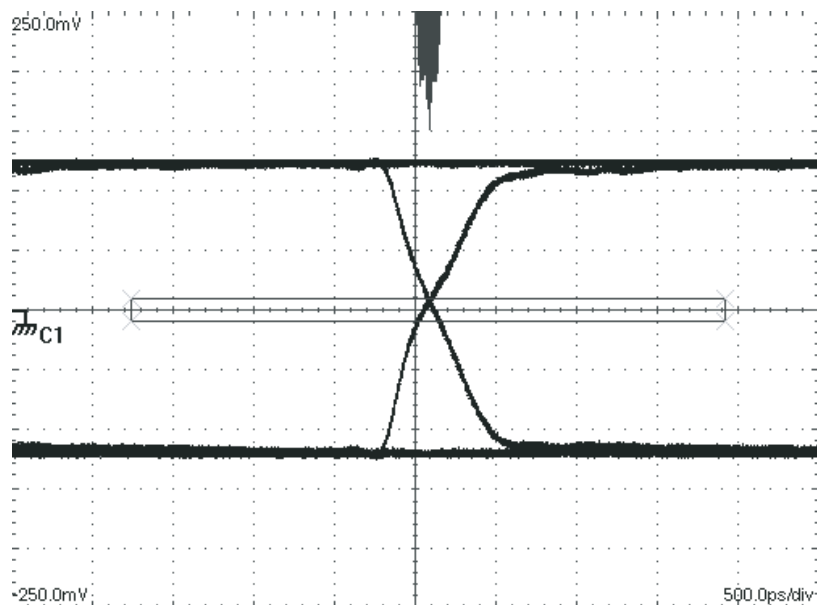
### 4.2 Output Interfacing

The GS9078A outputs are current mode, and will drive 800mV into a 75 $\Omega$  load. These outputs are protected from accidental static damage with internal static protection diodes.

The SMPTE 344M and SMPTE 259M standards require that the output of a cable driver have a source impedance of 75 $\Omega$  and a return loss of at least 15dB between 5MHz and 540MHz.

In order for an SDI output circuit using the GS9078A to meet this specification, the output application circuit shown in [Typical Application Circuit on page 11](#) is recommended.

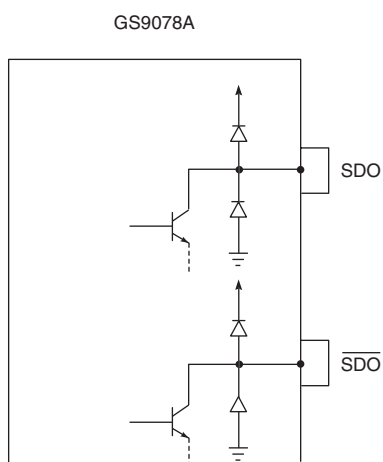
The value of  $L_{\text{COMP}}$  will vary depending on the PCB layout, with a typical value of 5.6nH. A 4.7 $\mu$ F capacitor is used for AC coupling the output of the device. This value is chosen to ensure that pathological signals can be coupled without a significant DC component occurring. Please see [Application Information on page 11](#) for more details.



**Figure 4-1: Output signal for 270Mb/s input**

The output protection diodes act as a varactor (voltage controlled capacitor) as shown in [Figure 4-2](#). Therefore, when measuring return loss at the GS9078A output, it is necessary to take the measurement for both a logic high and a logic low output condition.

Consequently, the output capacitance of the device is dependent on the logic state of the output.



**Figure 4-2: Static Protection Diodes**

## 4.3 Output Return Loss Measurement

To perform a practical return loss measurement, it is necessary to force the GS9078A output to a DC high or low condition. The actual measured return loss will be based on the outputs being static at  $V_{CC}$  or  $V_{CC}-1.6V$ . Under normal operating conditions the outputs of the device swing between  $V_{CC}-0.4V$  and  $V_{CC}-1.2V$ , so the measured value of return loss will not represent the actual operating return loss.

A simple method of calculating the values of actual operating return loss is to interpolate the two return loss measurements. In this way, the values of return loss are estimated at  $V_{CC}-0.4V$  and  $V_{CC}-1.2V$  based on the measurements at  $V_{CC}$  and  $V_{CC}-1.6V$ .

The two values of return loss (high and low) will typically differ by several decibels. If the measured return loss is  $R_H$  for logic high and  $R_L$  for logic low, then the two values can be interpolated as follows:

$$R_{IH} = R_H - (R_H - R_L)/4 \text{ and}$$

$$R_{IL} = R_L + (R_H - R_L)/4$$

where  $R_{IH}$  is the interpolated logic high value and  $R_{IL}$  is the interpolated logic low value.

For example, if  $R_H = -18dB$  and  $R_L = -14dB$ , then the interpolated values are  $R_{IH} = -17dB$  and  $R_{IL} = -15dB$ .

## 4.4 Output Amplitude (RSET)

The output amplitude of the GS9078A is set to  $800mV_{p-p}$  with a tolerance of  $\pm 7\%$  using an RSET resistor of  $750\Omega$ . A  $\pm 1\%$  SMT resistor should be used.

The  $R_{SET}$  resistor is part of the high speed output circuit of the GS9078A. The resistor should be placed as close as possible to the  $R_{SET}$  pin. In addition, the PCB capacitance should be minimized at this node by removing the PCB groundplane beneath the  $R_{SET}$  resistor and the  $R_{SET}$  pin.

NOTE: Only an  $R_{SET}$  value of  $750\Omega \pm 1\%$  should be used. Using other values for  $R_{SET}$  is not recommended.

## 5. Application Information

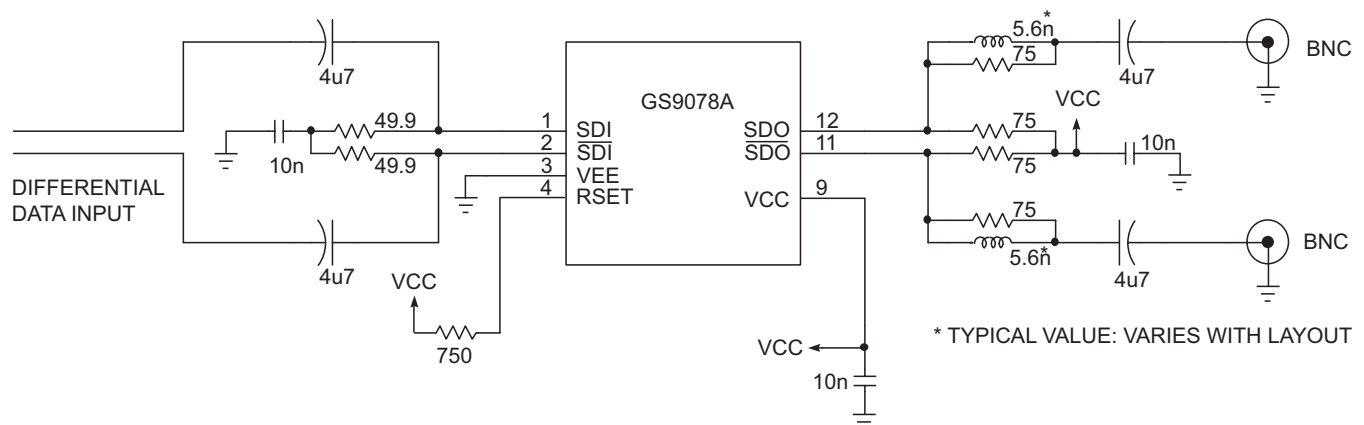
### 5.1 PCB Layout

Special attention must be paid to component layout when designing serial digital interfaces for SDTV.

An FR-4 dielectric can be used, however, controlled impedance transmission lines are required for PCB traces longer than approximately 1cm. Note the following PCB artwork features used to optimize performance:

- The PCB trace width for SD rate signals is closely matched to SMT component width to minimize reflections due to changes in trace impedance.
- The PCB groundplane is removed under the GS9078A output components to minimize parasitic capacitance.
- The PCB ground plane is removed under the GS9078A R<sub>SET</sub> pin and resistor to minimize parasitic capacitance.
- Input and output BNC connectors are surface mounted in-line to eliminate a transmission line stub caused by a BNC mounting via high speed traces which are curved to minimize impedance variations due to change of PCB trace width.

### 5.2 Typical Application Circuit

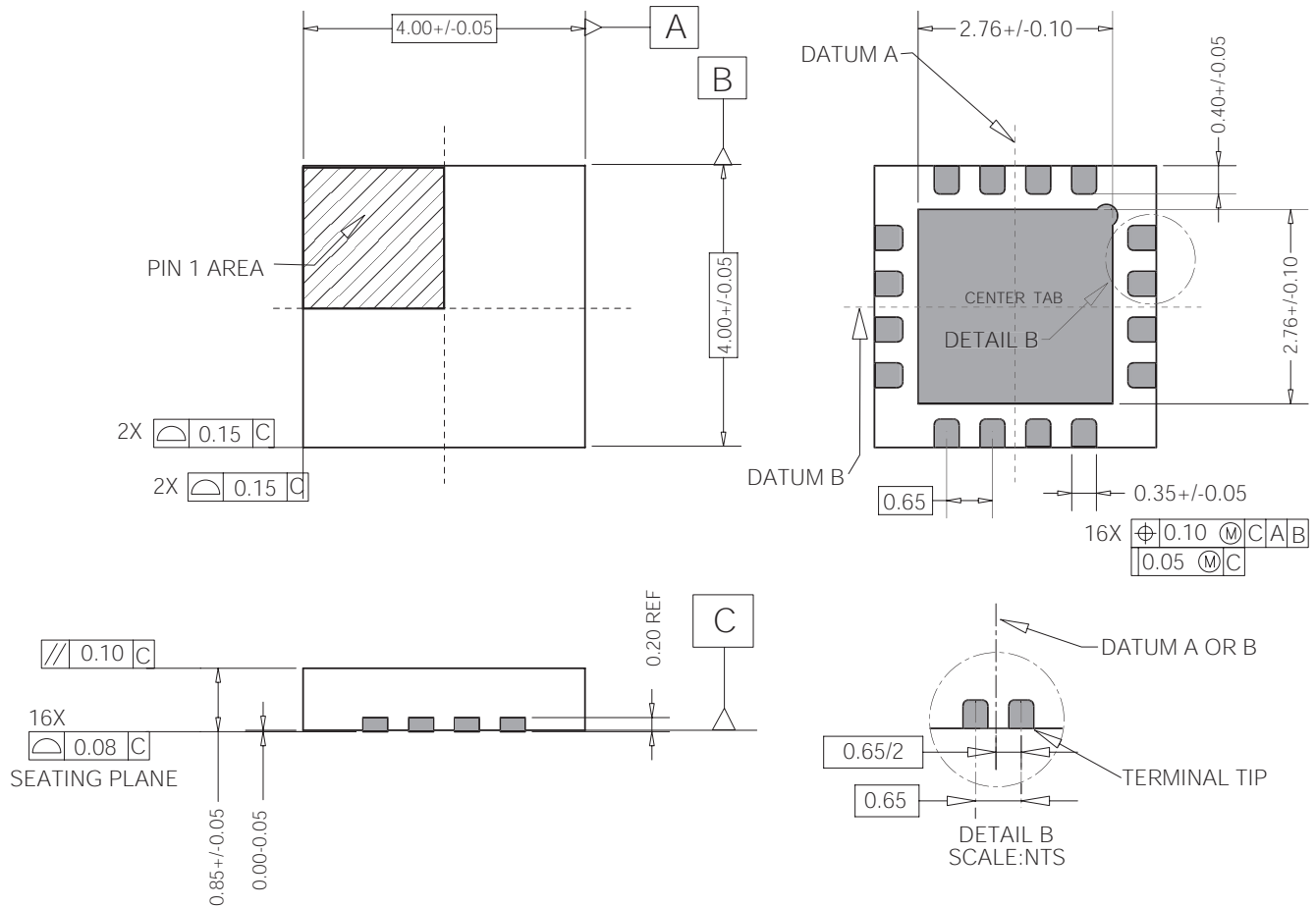


NOTE: All resistors in Ohms, capacitors in Farads, and inductors in Henrys, unless otherwise noted.

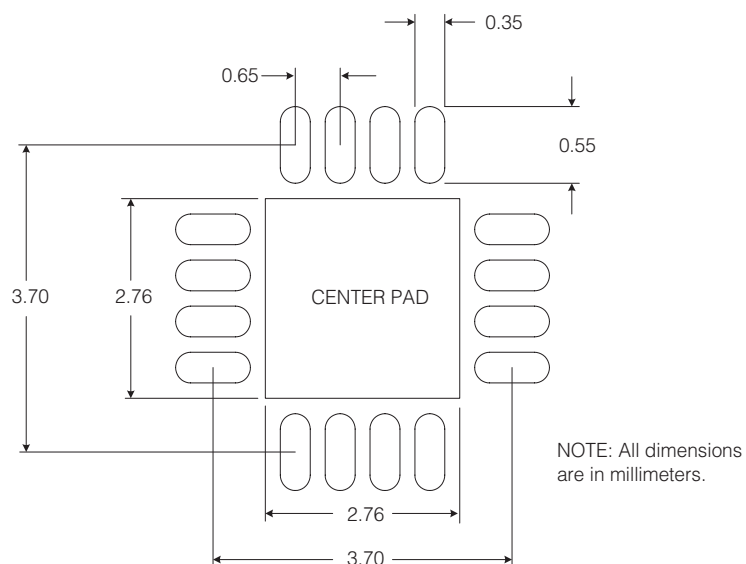
**Figure 5-1: Typical Application Circuit**

## 6. Package & Ordering Information

## 6.1 Package Dimensions



## 6.2 Recommended PCB Footprint



The Center Pad should be connected to the most negative power supply plane (VEE) by a minimum of 5 vias.

NOTE: Suggested dimensions only. Final dimensions should conform to customer design rules and process optimizations.

## 6.3 Packaging Data

| Parameter                                                            | Value                |
|----------------------------------------------------------------------|----------------------|
| Package Type                                                         | 4mm x 4mm 16-pin QFN |
| Package Drawing Reference                                            | JEDEC M0220          |
| Moisture Sensitivity Level                                           | 3                    |
| Junction to Case Thermal Resistance, $\theta_{j-c}$                  | 31.0°C/W             |
| Junction to Air Thermal Resistance, $\theta_{j-a}$ (at zero airflow) | 43.8°C/W             |
| Psi                                                                  | 11.0°C/W             |
| Pb-free and RoHS compliant                                           | Yes                  |

## 6.4 Ordering Information

|         | Part Number | Package    | Temperature Range |
|---------|-------------|------------|-------------------|
| GS9078A | GS9078ACNE3 | 16-pin QFN | 0°C to 70°C       |

## 7. Revision History

| Version | ECR    | PCN   | Date           | Changes and/or Modifications                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------|--------|-------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A       | 135926 | –     | February 2005  | New document.                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 0       | 136048 | –     | February 2005  | Converting to Preliminary Data Sheet. Added PCB Layout section. Updated Typical Application Circuit.                                                                                                                                                                                                                                                                                                                                                                     |
| 1       | 136655 | –     | June 2005      | Converted to Data Sheet. Changed title of <a href="#">Figure 2-2</a> to clarify that this is the Pb reflow profile. Updated Additive Jitter number in AC Electrical Characteristics table to be typically 20ps <sub>p-p</sub> . Updated dimensions of the center pad of the PCB footprint in <a href="#">Section 6.2</a> to match the dimensions of the center pad of the device. Corrected part number in ordering information. Rephrased the RoHS Compliant statement. |
| 2       | 137887 | –     | September 2005 | Corrected process to BiCMOS.                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 3       | 139115 | 38124 | January 2006   | Corrected Input Differential Swing to 2200mV.                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 4       | 139636 | 38695 | March 2006     | Corrected pad standoff height and tolerances for pad width & package dimension. Corrected pad shape.                                                                                                                                                                                                                                                                                                                                                                     |

### CAUTION

ELECTROSTATIC SENSITIVE DEVICES  
DO NOT OPEN PACKAGES OR HANDLE  
EXCEPT AT A STATIC-FREE WORKSTATION



### DOCUMENT IDENTIFICATION

#### DATA SHEET

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